## CHAPTER 8: MECHANICAL FAILURE



#### **ISSUES TO ADDRESS**

- How do flaws in a material initiate failure?
- How is fracture resistance quantified; how do different material classes compare?
- How do we estimate the stress to fracture?
- How do loading rate, loading history, and temperature affect the failure stress?

## **DUCTILE VS BRITTLE FAILURE**

Simple fracture is the separation of a body into two or more pieces in response to an imposed static stress at temperatures that are lower than material's melting point.

*Two* limiting fracture *modes* are possible for engineering materials: ductile and brittle



## **Example: FAILURE OF A PIPE**

- Ductile failure:
  - --one piece--large deformation





--many pieces --small deformation



## **MODERATELY DUCTILE FAILURE**

• Evolution of **cup-and-cone** fracture to failure:



Spherical (a) and parabolic (b) "dimples" characteristic for ductile fracture from uniaxial tensile and shear loadings

**Cup-and cone fracture of Al** 

### **BRITTLE FAILURE**



Brittle fracture in a mild steel



V-shaped "chevron" markings Characteristic of brittle fracture



**Intergranular** fracture (between grains)



**Intragranular** fracture (within grains)

## **Again: IDEAL vs. REAL MATERIALS**

• **History: Leonardo DaVinci** (500 years ago!) observed: the **longer the wire**, the **smaller** the **failure-causing load**.





- Reason:
  - flaws cause premature failure.
  - larger samples are more flawed!

### **FLAWS ARE STRESS CONCENTRATORS!**

Schematic of surface and internal cracks
 Stress distribution in front of a crack:



Characterized by: length (2**a**) curvature ( $\rho_t$ )

$$\sigma_{\rm m} = 2\sigma_{\rm o} (\frac{a}{\rho_{\rm t}})^{1/2}$$



• Stress concentration factor:

$$K_t = \sigma_{max} / \sigma_0$$

#### - stress amplification!



Plastic deformation ( $\sigma_m > \sigma_v$ ) leads to more uniform stress distribution!!

#### STRESS CONCENTRATORS: Macroscopic Level



• It is important to remember that stress amplification not only occurs on a *microscopic level* (e.g. small flaws or cracks,) but can also can take place on *the macroscopic level* in the case of sharp corners, holes, fillets, and notches.

• The figure depicts the theoretical stress concentration factor curves for several simple and common material geometries.

### **Reminder: TOUGHNESS**

- Energy to break a unit volume of material
- Approximate by the area under the stress-strain curve.
- Units: [J/m<sup>2</sup>]



**For Elastic Strain** 



$$\boldsymbol{\sigma}_{n} = E\boldsymbol{\varepsilon}_{n}$$
$$U^{el} = \int \boldsymbol{\sigma}_{n} d\boldsymbol{\varepsilon}_{n} = \int \boldsymbol{\sigma}_{n} \frac{d\boldsymbol{\sigma}_{n}}{E} = \left\{ \frac{\boldsymbol{\sigma}_{n}^{2}}{2E} \right\}$$

#### **Material Fast Fracture**

### Fixed displacements case (the boundary of the plate are fixed)





 $\delta W \geq \delta U^{el} + \gamma_c t \delta a$  $-\delta U^{el} = \gamma_c t \delta a$  $U^{el} = -\frac{\sigma^2}{2E} \frac{\pi a^2 t}{2}$  $\delta U^{el} = \frac{\delta U^{el}}{\delta a} \delta a = -\frac{\sigma^2}{2E} \frac{2\pi at}{2} \delta a$  $\frac{\sigma^2 \pi a}{2E} = \gamma_c$  $\sigma_c = \left(\frac{2E\gamma_c}{\pi a}\right)^{1/2}$ 

where E – module of elasticity;  $\sigma_c$  – critical stress;  $\gamma_s$  – **toughness** (J m<sup>-2,</sup> specific surface energy); W-work; U<sup>el</sup>- energy related to elastic deformation

## **1: FRACTURE TOUGHNESS**

• Thus it is possible to show that critical stress for crack propagation is:

Stress intensity factor  $\rightarrow$ 

$$\sigma \sqrt{\pi a} = \sqrt{E \gamma_c} \leftarrow \text{Material properties}$$
only!!!

• Fracture toughness is a property that is a measure of a materials' resistance for brittle fracture when cracks are present. This property can be defined by parameter  $K_c$  that relates the critical stress for crack propagation and geometry of the crack:

$$K_c = Y\sigma_c\sqrt{\pi a}$$

where  $\mathbf{Y}$  – a dimensionless parameter that depends on both crack and specimen sizes and geometries (is tabulated for different crack-specimen geometries), as well as the type of load application

# **GEOMETRY, LOAD, & MATERIAL**

Condition for crack propagation:



## Mechanisms of Crack Propagation: ductile tearing





 $\mathbf{K}^2$ 

 $2\pi\sigma_v^2$ 

The plastic flow at the crack tip naturally turns the initially sharp crack into a *blunt crack*. Crack blunting decreases  $\sigma_m$  so that crack tip itself can keep on plastically deforming. Thus ductile tearing *consumes a lot of energy by plastic flow.* This is why ductile materials are so *tough*.



 $r_v =$ 

 $2\sigma_v^2$ 

### Mechanisms of Crack Propagation: cleavage



$$r = \frac{\sigma^2 a}{2\sigma_y^2} = \frac{K^2}{2\pi\sigma_y^2}$$
$$K = K_c$$

Blunting of the sharp crack does not occur/ The local stress at the crack tip is large enough to **break apart the inter-atomic bonds**!!

The crack spreads between a pair of atomic planes leading to the formation of flat surfaces by *cleavage*.



# **IMPACT FRACTURE TESTING**

#### Charpy V-notch (CVN) technique

represents the most severe relative to the potential for fracture conditions:

- deformation at low temperature;
- a high strain rate

- a tri-axial stress state introduced by a notch and is used to measure the **impact energy** or notch toughness





# **Temperature and Strain Rate**



- Samples (a) and (b) are both glass, but (a) was tested at 800 K and behaved in a ductile (viscoelastic) way whereas (b) was tested at 273 K and showed brittle behavior.
- Poly-propylene samples (c) and (d) were tested at the same temperature but at different strain rates. At low strain rates (c) this polymer is ductile but at high strain rates (d) it shows brittle fracture.

### **TEMPERATURE**

- Increase of temperature leads to the increase of shear fracture and K<sub>c</sub>
- Ductile-to-brittle transition temperature (DBTT)





#### **FRACTURE TOUGHNESS**

## FATIGUE

• Fatigue is a failure under cyclic stress (bridges, aircraft etc.).



- key parameters are S,  $\sigma_{mean}$ ,  $\Delta\sigma$ 

$$\sigma_{m} = \frac{\sigma_{\max} + \sigma_{\min}}{2}$$
$$\Delta \sigma_{a} = S = \frac{\sigma_{\max} - \sigma_{\min}}{2}$$

#### • Key points:

- Fatigue can cause part failure, even though  $\sigma_{max} < \sigma_c$ , i.e. at lower strength than for a static conditions;
- Fatigue causes ~ 90% of mechanical engineering failures.



Fatigue-testing apparatus for rotating-bending test: main parameters **S** and number of cycles (N)

## **Fatigue Failure: Classification**



## Fatigue of Un-Cracked Component: high cycle fatigue



### Fatigue of Un-Cracked Component: low-cycle fatigue



## Fatigue Mechanism: un-cracked structures



Low-cycle fatigue: The general plasticity quickly roughens the surface and crack *forms there*, first propagating along a *slip plane* and then normal to the tensile axis



High-cycle fatigue:Stress is below  $\sigma_y$ , thus essentially all<br/>of the life is time up in *initiating* a<br/>crack in the place of local plasticity,<br/>which is related to the *zones of stress*<br/>*concentrations*. Formed crack<br/>propagates slowly at first and then<br/>faster, until component fails.

## **Fatigue of Cracked Component**



Time

Time

 $\Delta K = K_{max} - K_{min} = \Delta \sigma(\pi a)^{1/2}$ 

The cycle stress intensity  $\Delta K$ increases with time (at constant S) because the crack growth increases tension.

For example in steady-state regime the crack growth rate is:

 $da/dN = A \Delta K^m$ 

where A and m are materials' constant

$$N_{f} = \int_{0}^{N_{f}} dN = \int_{a_{o}}^{a_{f}} \frac{da}{A(\Delta K)^{m}} = \int_{a_{o}}^{a_{f}} \frac{da}{A[\Delta \sigma(\pi a)^{1/2}]^{m}}$$

Large, particularly welded structures (bridge, ships, nuclear reactors)

## Fatigue Mechanism: pre-cracked structures



• In pure metals or polymers the tensile stress produces a plastic zone which makes the crack tip stretch open by the amount of  $\delta$ , creating a new surface there.

• As the stress is removed the crack closes and new surface folds forward extending crack ~  $\delta$ .

•On the next cycle the same happens again and crack moves with rate da/dN~δ.

• Inclusions make the crack propagate even faster.

#### **S-N DIAGRAMS: FATIGUE DESIGN PARAMETERS**



• Fatigue limit, S<sub>fat</sub>: -no fatigue if S < S<sub>fat</sub>





• Sometimes, the fatigue limit is zero!

#### Factors affect fatigue life:

- increasing the **mean stress** leads to a decrease in fatigue life
- **surface effects:** design factor, surface treatment

### **IMPROVING FATIGUE LIFE**



## **3: CREEP**

 Creep is deformation at elevated temperature (T > 0.4 T<sub>melt</sub>) but under static mechanical stress



- But in this case deformation changes with time!!
- Three characteristic regions:
  - primary creep: creep rate decreases
  - secondary creep: steady-state creep,
  - tertiary creep: creep rate acceleration

## What is low T and what is high T?



Examples: Tungsten ~ 3000 °C Lead ~ 400° C Ice ceramic 0 °C - !!

T> 0.3 to 0.4  $T_M$  for metals T> 0.4 to 0.5  $T_M$  for ceramics Polymers also creep – many of them do so at room temperature

## **Creep Curve**



#### t<sub>r</sub>, Creep rapture time

- Three characteristic regions:
  - primary creep: creep rate decreases
  - secondary creep: steady-state creep,
  - tertiary creep: creep rate acceleration

## **Steady-State (Secondary)** Creep

- Typically the longest duration stage of creep
- Strain rate is constant at a given T and σ, because strain hardening is balanced by recovery!!!



#### the strain rate increases for larger T, $\boldsymbol{\sigma}$

**Steady-State Creep** 

#### **Stress Dependence**



$$\dot{\varepsilon}_{ss} = B\sigma^n$$

#### **Temperature Dependence**



$$\dot{\varepsilon}_{ss} = Ce^{-(Q/RT)}$$

## **Creep Mechanisms: Dislocation Creep**



Climb unlocks dislocations from precipitate which pin them And further slip may take place!!

 $D=D_o exp(-Q/RT)$ 

$$\dot{\varepsilon}_{ss} = A\sigma^n e^{-(Q/RT)}$$

• At lower end of the creep regime (0.3-0.5Tm) **core diffusion** tends to dominate; at the higher end (0.5-0.9TM) it is **bulk diffusion** 

## **Creep Mechanisms: Diffusion Creep**



At **lower stresses** the rate of power –law creep falls quickly (from n = 3 - 8 to n=1). Creep does not stop, but rather proceeds by an **alternative mechanism**, i.e. a polycrystal can extend in response to applied stress by grain elongation!

In this case **atoms diffuse** from one set of the grain faces to the another and dislocations are not involved.

$$\dot{\epsilon}_{ss} = CD\sigma/d_2 = C'\sigma e^{-(Q/RT)}/d^2$$

## **Creep Relaxation**



At constant displacement, creep causes stresses to relax with time!

Example: Bolts in hot turbine must be regularly tightened; plastic paper-clips are not, in the long term, as good as a steel ones.

The relaxation time (arbitrary defined as time taken for the stress to relax to half of original value) can be estimated as follows:

$$\varepsilon^{\text{total}} = \varepsilon^{\text{elastic}} + \varepsilon^{\text{creep}}$$

$$\varepsilon^{\text{el}} = \sigma/e$$

$$\dot{\varepsilon}^{\text{cr}} = B\sigma^{n}$$

$$\varepsilon^{\text{total}} = \text{const}$$

$$\frac{1}{e} \cdot \frac{d\sigma}{dt} = -B\sigma^{n}$$
Integrating from  $\sigma = \sigma_{\text{in}}$  to  $\sigma = \sigma_{\text{in}}/2$ 

$$t_{r} = \frac{(2^{n-1} - 1)}{(n-1)BE\sigma_{\text{in}}^{n-1}}$$

# **Creep Damage and Creep Fracture**

Damage in the form of internal cavities, accumulates during Tertiary Stage of creep

Time-to-failure is described by equation which looks like that for creep itself:

$$t_f = A' \sigma^{-m} e^{Q/RT}$$









- the rapture time diminishes for larger T,  $\boldsymbol{\sigma}$ 

### **CREEP FAILURE**

#### Failure: along grain boundaries.



• Time to rupture, t<sub>r</sub>

$$T(20 + \log t_r) = L$$
temperature function of applied stress
time to failure (rupture)

Estimate rupture time
 S-590 Iron, T = 800°C, σ = 20 ksi



## SUMMARY

- Engineering materials don't reach theoretical strength.
- Flaws produce stress concentrations that cause premature failure.
- Sharp corners also produce large stress concentrations and premature failure.
- Failure type depends on stress and T:
  - -for non-cyclic  $\sigma$  and T < 0.4T<sub>m</sub>, failure stress decreases with: increased maximum flaw size, decreased T,
  - -for cyclic:
    - cycles to fail decreases as  $\Delta \sigma$  increases.
  - -for higher T (T >  $0.4T_m$ ):
    - time to fail decreases as  $\sigma$  or T increases.